ON Semiconductor®



# 4-Channel Headset EMI Filter Array with ESD Protection

CM1410

#### **Features**

- Functionally and pin compatible with the CSPEMI200A device
- Pi-style EMI filters in a capacitor-resistorcapacitor (C-R-C) network
- Four channels of EMI filtering with ESD protection
- Includes one channel of ESD-only protection
- Greater than 30dB attenuation at 1GHz
- ±8kV ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- ±15kV ESD protection on each channel (HBM)
- Supports bipolar signals—ideal for audio applications
- Chip Scale Package features extremely low lead inductance for optimum filter and ESD performance
- 11-bump, 2.046mm X 1.436mm footprint Chip Scale Package (CSP)
- Optiguard<sup>™</sup> coated for improved reliability at assembly
- RoHS-compatible, lead-free packaging

## **Applications**

- EMI filtering and ESD protection for audio ports
- · Wireless handsets
- Handheld PCs / PDAs
- MP3 players
- Digital camcorders
- Notebooks
- Desktop PCs

#### **Product Description**

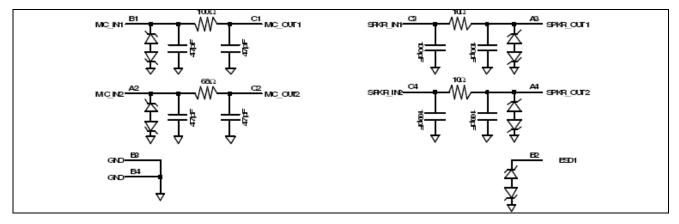
The CM1410 is a quad low-pass filter array integrating four pi-style filters (C-R-C) that reduce EMI/RFI emissions while at the same time providing ESD protection. This device is custom-designed to interface with the headset port on a cellular telephone, and contains three different filter values. Each high quality filter provides more than 20dB attenuation in the 800-2700 MHz range. These pistyle filters support bidirectional filtering, controlling EMI both to and from the microphone and speaker elements. They also support bipolar signals, enabling audio signals to pass through without distortion.

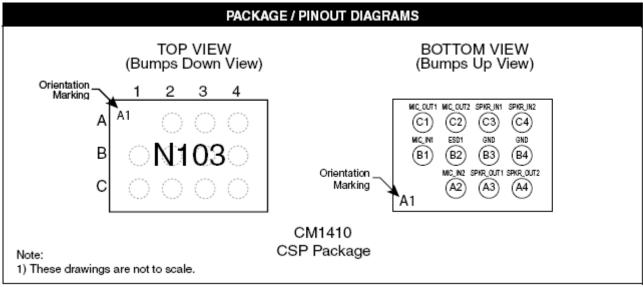
In addition, the CM1410 provides a very high level of protection for sensitive electronic components that may be subject to electrostatic discharge (ESD). The CM1410 can safely dissipate ESD strikes of ±8kV, the maximum requirement of the IEC 61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the device provides protection for contact discharges to greater than ±15kV. The CM1410 also includes a single channel of ESD-only protection.

The CM1410 is particularly well suited for portable electronics (e.g., cellular telephones, PDAs, notebook computers) because of its small package format and low weight.

The CM1410 incorporates *Optiguard™* coating which results in improved reliability at assembly. The CM1410 is available in a space-saving, low-profile RoHS-compliant, Chip Scale Package.

## **Block Diagram**





	PIN DESCRIPTIONS						
PIN	NAME	DESCRIPTION					
A1	N.B.	No Bump – used for orientation / alignment					
A2	MIC_IN2	Microphone Input 2 (from microphone)					
А3	SPKR_OUT1	Speaker Output 1 (to speaker)					
A4	SPKR_OUT2	Speaker Output 2 (to speaker)					
B1	MIC_IN1	Microphone Input 1 (from microphone)					
B2	ESD1	ESD Protection Input. Provides a channel specifically for ESD protection purposes.					
ВЗ	GND	Device Ground					
B4	GND	Device Ground					
C1	MIC_OUT1	Microphone Output 1 (to audio circuitry)					
C2	MIC_OUT2	Microphone Output 2 (to audio circuitry)					
C3	SPKR_IN1	Speaker Input 1 (from audio circuitry)					
C4	SPKR_IN2	Speaker Input 2 (from audio circuitry)					

# **Ordering Information**

PART NUMBERING INFORMATION							
Bumps	Package	Ordering Part Number <sup>1</sup>	Part Marking				
11	CSP	CM1410-03CP	N103				

Note 1: Parts are shipped in Tape and Reel form unless otherwise specified.

# **Specifications**

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	RATING	UNITS			
Storage Temperature Range	-65 to +150	℃			
DC Power per Resistor	100	mW			
DC Package Power Rating	400	mW			

STANDARD OPERATING CONDITIONS					
PARAMETER	RATING	UNITS			
Operating Temperature Range	-40 to +85	Ç			

	ELECTRICAL OPERATING CHARACTERISTICS (NOTE 1)					
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
R,	Resistance 1		90	100	110	Ω
R <sub>2</sub>	Resistance 2		61	68	75	Ω
R <sub>3</sub>	Resistance 3		9	10	11	Ω
C <sub>1</sub>	Capacitance 1		38	47	57	pF
C <sub>2</sub>	Capacitance 2		80	100	120	pF
I <sub>LEAK</sub>	Diode Leakage Current	V <sub>IN</sub> =5.0V			1.0	μΑ
V <sub>SIG</sub>	Signal Voltage Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10mA	5 -15	7 -10	15 -5	V
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	Notes 2 and 4	±15 ±8			kV kV
V <sub>CL</sub>	Clamping Voltage during ESD Discharge MIL-STD-883 (Method 3015), 8kV Positive Transients Negative Transients	Notes 2,3 and 4		+15 -19		V V
f <sub>C1</sub>	Cut-off frequency 1; Note 5	R = 100Ω, C = 47pF		53		MHz
f <sub>C2</sub>	Cut-off frequency 2; Note 5	R = 68Ω, C = 47pF		61		MHz
f <sub>c3</sub>	Cut-off frequency 3; Note 5	R = 10Ω, C = 100pF		33		MHz

Note 1:  $T_A=25\,^{\circ}\text{C}$  unless otherwise specified. Note 2: ESD applied to input pins with respect to GND, one at a time, pins A2, A3, A4, B1 and B2 only.

Note 3: Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin. For example, if ESD is applied to Pin B1, then clamping voltage is measured at Pin C1.

Note 4: Unused pins are left open

Note 5:  $Z_{SOURCE} = 50\Omega$ ,  $Z_{LOAD} = 50\Omega$ 

## **Performance Information**

Typical Filter Performance (nominal conditions unless specified otherwise)

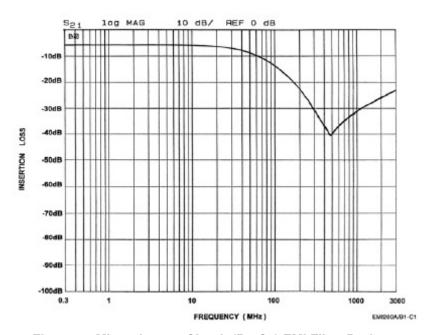


Figure 1. Microphone 1 Circuit (B1-C1) EMI Filter Performance

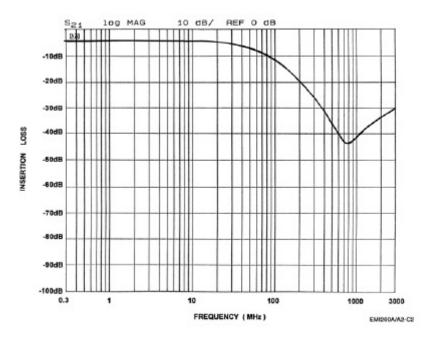


Figure 2. Microphone 2 Circuit (A2-C2) EMI Filter Performance

## Performance Information (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise)

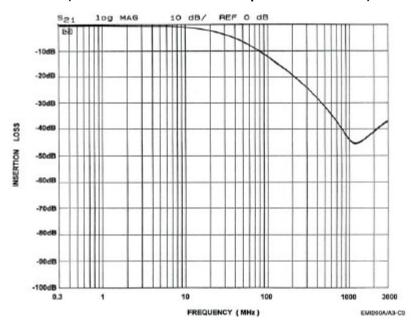


Figure 3. Speaker 1 Circuit (A3-C3) EMI Filter Performance

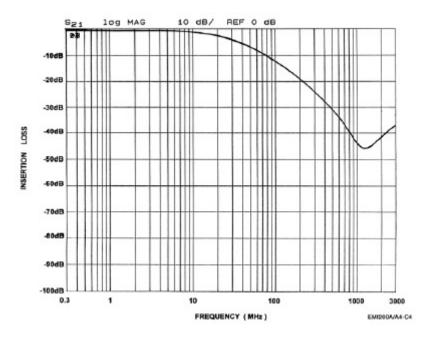


Figure 4. Speaker 2 Circuit (A4-C4) EMI Filter Performance

## **Application Information**

PARAMETER	VALUE
Pad Size on PCB	0.240mm
Pad Shape	Round
Pad Definition	Non-Solder Mask defined pads
Solder Mask Opening	0.290mm Round
Solder Stencil Thickness	0.125mm - 0.150mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300mm Round
Solder Flux Ratio	50/50 by volume
Solder Paste Type	No Clean
Pad Protective Finish	OSP (Entek Cu Plus 106A)
Tolerance — Edge To Corner Ball	<u>+</u> 50μm
Solder Ball Side Coplanarity	<u>+</u> 20μm
Maximum Dwell Time Above Liquidous	60 seconds
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260℃

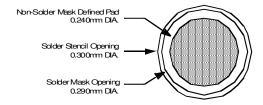


Figure 5. Recommended Non-Solder Mask Defined Pad Illustration

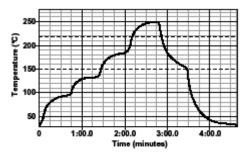


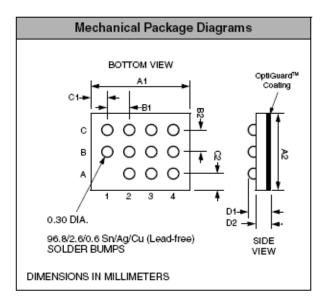
Figure 6. Lead-free (SnAgCu) Solder Ball Reflow Profile

## **Mechanical Details**

#### **CSP Mechanical Specifications**

The CM1410 is supplied in a custom Chip Scale Package (CSP). Dimensions are presented below.

PACKAGE DIMENSIONS							
Pack	age	Custom CSP					
Bun	nps	11					
Dim	М	lillimeters			Inches		
Diiii	Min	Nom	Max	Min	Nom	Max	
A1	2.001	2.046	2.091	0.0788	0.0806	0.0823	
A2	1.391	1.436	1.481	0.0548	0.0565	0.0583	
B1	0.495	0.500	0.505	0.0195	0.0197	0.0199	
B2	0.495	0.500	0.505	0.0195	0.0195     0.0197       0.0088     0.0107		
C1	0.223	0.273	0.323	0.0088			
C2	0.168	0.218	0.268	0.0066	0.0086	0.0106	
D1	0.575	0.644	0.714	0.0226	0.0254	0.0281	
D2	0.368	0.419	0.470	0.0145	0.0165	0.0185	
# per tape and reel		3500 pieces					
	Controlling dimension: millimeters						



Package Dimensions for CM1410 Chip Scale Package

#### **CSP Tape and Reel Specifications**

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B <sub>o</sub> X A <sub>o</sub> X K <sub>o</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P <sub>o</sub>	P <sub>1</sub>
CM1410	2.05 X 1.44 X 0.644	2.29 X 1.60 X 0.81	8mm	178mm (7")	3500	4mm	4mm

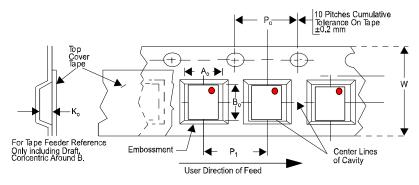


Figure 7. Tape and Reel Mechanical Data

CM1410

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 N. American Technical Support: 800-282-9655 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative